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	Type	Hits	Search Text	DBs	Time Stamp
1	IS&R	37	("257/633").CCLS.	USPAT	2000/09/14 11:57
2	IS&R	74	("257/638").CCLS.	USPAT	2000/09/14 12:07
3	IS&R	342	("257/701").CCLS.	USPAT	2000/09/14 12:07
4	BRS	9	((257/701.CCLS.) AND INTERPOSER)	USPAT	2000/09/14 12:07
5	BRS	121256 0	"integrated circuit" or semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:55
6	BRS	81313	("integrated circuit" or semiconductor) and package	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:55
7	BRS	121044 7	"integrated circuit" or semiconductor	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:56
8	BRS	81313	("integrated circuit" or semiconductor) and package	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:56
9	BRS	78118	("integrated circuit" or semiconductor) and package and @ad<19990730	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:57
10	BRS	633	((("integrated circuit" or semiconductor) and package) and @ad<19990730) and interposer	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:57
11	BRS	298	((("integrated circuit" or semiconductor) and package) and @ad<19990730) and interposer) and adhesive	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:57
12	BRS	136747 8	pad or piece	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:58
13	BRS	263	((("integrated circuit" or semiconductor) and package) and @ad<19990730) and interposer) and adhesive) and (pad or piece)	USPAT; EPO; JPO; DERWENT; IBM TDB	2001/07/24 19:58